

Film Capacitors

Metallized Polyester Film Capacitors (MKT)

Series/Type: B32232
Date: May 2009

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32232A6154J189		2012-08-24	2012-11-30	2013-02-28
B32232A6154J000		2012-08-24	2012-11-30	2013-02-28
B32232A6104K189		2012-08-24	2012-11-30	2013-02-28

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Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32232A6104K000		2012-08-24	2012-11-30	2013-02-28
B32232A6104J189		2012-08-24	2012-11-30	2013-02-28
B32232A6104J000		2012-08-24	2012-11-30	2013-02-28
B32232A3684K189		2012-08-24	2012-11-30	2013-02-28
B32232A3684K000		2012-08-24	2012-11-30	2013-02-28
B32232A3684J189		2012-08-24	2012-11-30	2013-02-28
B32232A3684J000		2012-08-24	2012-11-30	2013-02-28
B32232A3474K189		2012-08-24	2012-11-30	2013-02-28
B32232A3474K000		2012-08-24	2012-11-30	2013-02-28
B32232A3474J189		2012-08-24	2012-11-30	2013-02-28
B32232A3474J000		2012-08-24	2012-11-30	2013-02-28
B32232A3334K189		2012-08-24	2012-11-30	2013-02-28
B32232A3334K000		2012-08-24	2012-11-30	2013-02-28
B32232A3334J189		2012-08-24	2012-11-30	2013-02-28
B32232A3334J000		2012-08-24	2012-11-30	2013-02-28
B32232A3225K189		2012-08-24	2012-11-30	2013-02-28
B32232A3225K000		2012-08-24	2012-11-30	2013-02-28
B32232A3225J189		2012-08-24	2012-11-30	2013-02-28
B32232A3225J000		2012-08-24	2012-11-30	2013-02-28
B32232A3224K189		2012-08-24	2012-11-30	2013-02-28
B32232A3224K000		2012-08-24	2012-11-30	2013-02-28
B32232A3224J189		2012-08-24	2012-11-30	2013-02-28
B32232A3224J000		2012-08-24	2012-11-30	2013-02-28
B32232A3155K189		2012-08-24	2012-11-30	2013-02-28
B32232A3155K000		2012-08-24	2012-11-30	2013-02-28
B32232A3155J189		2012-08-24	2012-11-30	2013-02-28
B32232A3155J000		2012-08-24	2012-11-30	2013-02-28
B32232A3154K189		2012-08-24	2012-11-30	2013-02-28
B32232A3154K000		2012-08-24	2012-11-30	2013-02-28
B32232A3154J189		2012-08-24	2012-11-30	2013-02-28
B32232A3154J000		2012-08-24	2012-11-30	2013-02-28
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B32232A3105J000		2012-08-24	2012-11-30	2013-02-28
B32232A3104K189		2012-08-24	2012-11-30	2013-02-28
B32232A3104K000		2012-08-24	2012-11-30	2013-02-28
B32232A3104J189		2012-08-24	2012-11-30	2013-02-28



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32232A3104J000		2012-08-24	2012-11-30	2013-02-28
B32232A1684K189		2012-08-24	2012-11-30	2013-02-28
B32232A1684K000		2012-08-24	2012-11-30	2013-02-28
B32232A1684J189		2012-08-24	2012-11-30	2013-02-28
B32232A1684J000		2012-08-24	2012-11-30	2013-02-28
B32232A1475K189		2012-08-24	2012-11-30	2013-02-28
B32232A1475K000		2012-08-24	2012-11-30	2013-02-28
B32232A1475J189		2012-08-24	2012-11-30	2013-02-28
B32232A1475J000		2012-08-24	2012-11-30	2013-02-28
B32232A1474K189		2012-08-24	2012-11-30	2013-02-28
B32232A1474K000		2012-08-24	2012-11-30	2013-02-28
B32232A1474J189		2012-08-24	2012-11-30	2013-02-28
B32232A1474J000		2012-08-24	2012-11-30	2013-02-28
B32232A1335K189		2012-08-24	2012-11-30	2013-02-28
B32232A1335K000		2012-08-24	2012-11-30	2013-02-28
B32232A1335J189		2012-08-24	2012-11-30	2013-02-28
B32232A1335J000		2012-08-24	2012-11-30	2013-02-28
B32232A1334K189		2012-08-24	2012-11-30	2013-02-28
B32232A1334K000		2012-08-24	2012-11-30	2013-02-28
B32232A1334J189		2012-08-24	2012-11-30	2013-02-28
B32232A1334J000		2012-08-24	2012-11-30	2013-02-28
B32232A1225K189		2012-08-24	2012-11-30	2013-02-28
B32232A1225K000		2012-08-24	2012-11-30	2013-02-28
B32232A1225J189		2012-08-24	2012-11-30	2013-02-28
B32232A1225J000		2012-08-24	2012-11-30	2013-02-28
B32232A1224K189		2012-08-24	2012-11-30	2013-02-28
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B32232A1224J189		2012-08-24	2012-11-30	2013-02-28
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B32232A1155K189		2012-08-24	2012-11-30	2013-02-28
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B32232A1154J189		2012-08-24	2012-11-30	2013-02-28
B32232A1154J000		2012-08-24	2012-11-30	2013-02-28
B32232A1105K189		2012-08-24	2012-11-30	2013-02-28



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32232A1105K000		2012-08-24	2012-11-30	2013-02-28
B32232A1105J189		2012-08-24	2012-11-30	2013-02-28
B32232A1105J000		2012-08-24	2012-11-30	2013-02-28
B32232A1104K189		2012-08-24	2012-11-30	2013-02-28
B32232A1104K000		2012-08-24	2012-11-30	2013-02-28
B32232A1104J189		2012-08-24	2012-11-30	2013-02-28
B32232A1104J000		2012-08-24	2012-11-30	2013-02-28
B32232A8683K189		2012-08-24	2012-11-30	2013-02-28
B32232A8683K000		2012-08-24	2012-11-30	2013-02-28
B32232A8683J189		2012-08-24	2012-11-30	2013-02-28
B32232A8683J000		2012-08-24	2012-11-30	2013-02-28
B32232A8474K000		2012-08-24	2012-11-30	2013-02-28
B32232A8474J000		2012-08-24	2012-11-30	2013-02-28
B32232A8473K189		2012-08-24	2012-11-30	2013-02-28
B32232A8473K000		2012-08-24	2012-11-30	2013-02-28
B32232A8473J189		2012-08-24	2012-11-30	2013-02-28
B32232A8473J000		2012-08-24	2012-11-30	2013-02-28
B32232A8334K189		2012-08-24	2012-11-30	2013-02-28
B32232A8334K000		2012-08-24	2012-11-30	2013-02-28
B32232A8334J189		2012-08-24	2012-11-30	2013-02-28
B32232A8334J000		2012-08-24	2012-11-30	2013-02-28
B32232A8333K189		2012-08-24	2012-11-30	2013-02-28
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B32232A8333J189		2012-08-24	2012-11-30	2013-02-28
B32232A8333J000		2012-08-24	2012-11-30	2013-02-28
B32232A8224K189		2012-08-24	2012-11-30	2013-02-28
B32232A8224K000		2012-08-24	2012-11-30	2013-02-28
B32232A8224J189		2012-08-24	2012-11-30	2013-02-28
B32232A8224J000		2012-08-24	2012-11-30	2013-02-28
B32232A8154K189		2012-08-24	2012-11-30	2013-02-28
B32232A8154K000		2012-08-24	2012-11-30	2013-02-28
B32232A8154J189		2012-08-24	2012-11-30	2013-02-28
B32232A8154J000		2012-08-24	2012-11-30	2013-02-28
B32232A8104K189		2012-08-24	2012-11-30	2013-02-28
B32232A8104K000		2012-08-24	2012-11-30	2013-02-28
B32232A8104J189		2012-08-24	2012-11-30	2013-02-28
B32232A8104J000		2012-08-24	2012-11-30	2013-02-28
B32232A6684K189		2012-08-24	2012-11-30	2013-02-28



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B32232A6684K000		2012-08-24	2012-11-30	2013-02-28
B32232A6684J189		2012-08-24	2012-11-30	2013-02-28
B32232A6684J000		2012-08-24	2012-11-30	2013-02-28
B32232A6474K189		2012-08-24	2012-11-30	2013-02-28
B32232A6474K000		2012-08-24	2012-11-30	2013-02-28
B32232A6474J189		2012-08-24	2012-11-30	2013-02-28
B32232A6474J000		2012-08-24	2012-11-30	2013-02-28
B32232A6334K189		2012-08-24	2012-11-30	2013-02-28
B32232A6334K000		2012-08-24	2012-11-30	2013-02-28
B32232A6334J189		2012-08-24	2012-11-30	2013-02-28
B32232A6334J000		2012-08-24	2012-11-30	2013-02-28
B32232A6224K189		2012-08-24	2012-11-30	2013-02-28
B32232A6224K000		2012-08-24	2012-11-30	2013-02-28
B32232A6224J189		2012-08-24	2012-11-30	2013-02-28
B32232A6224J000		2012-08-24	2012-11-30	2013-02-28
B32232A6154K189		2012-08-24	2012-11-30	2013-02-28
B32232A6154K000		2012-08-24	2012-11-30	2013-02-28

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.epcos.com/sales.

General purpose (wound)
Typical applications

- Smoothing
- Filtering

Climatic

- Max. operating temperature: 100 °C
- Climatic category (IEC 60068-1): 40/100/21

Construction

- Dielectric: polyethylene terephthalate (polyester, PET)
- Cylindrical winding
- Insulating sleeve
- Face ends sealed with epoxy resin

Terminals

- Central axial wire leads, lead-free tinned

Marking

Manufacturer, series number, rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage, date of manufacture (coded)

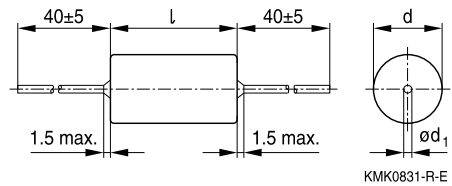
Delivery mode

Bulk (untaped)
Taped (reel)

For notes on taping, refer to chapter "Taping and packing".

Detail specification

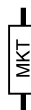
DIN 45910-112

Dimensional drawing


Dimensions in mm

Diameter d	Lead diameter d ₁
≤ 7.0	0.6
> 7.0	0.8

When bending leads take care to leave a clearance of 1 mm to the capacitor body.


Overview of available types

Type	B32232			
V_R (V DC)	100	250	400	630
V_{RMS} (V AC)	63	160	200	200
C_R (μ F)				
0.033				
0.047				
0.068				
0.10				
0.15				
0.22				
0.33				
0.47				
0.68				
1.0				
1.5				
2.2				
3.3				
4.7				
6.8				


B32232
General purpose (wound)
Ordering codes and packing units

V_R	V_{RMS} $f \leq 60$ Hz	C_R	Max. dimensions $d \times l$	Ordering code (composition see below)	Reel pcs./MOQ	Untaped pcs./MOQ
V DC	V AC	μF	mm			
100	63	0.10	6.0 × 14.0	B32232A1104+***	4000	2000
		0.15	6.0 × 14.0	B32232A1154+***	4000	2000
		0.22	6.0 × 14.0	B32232A1224+***	4000	2000
		0.33	6.0 × 19.0	B32232A1334+***	4000	2000
		0.47	6.5 × 19.0	B32232A1474+***	4000	2000
		0.68	7.0 × 19.0	B32232A1684+***	4000	2000
		1.0	8.5 × 19.0	B32232A1105+***	4000	2000
		1.5	8.0 × 27.0	B32232A1155+***	4000	2000
		2.2	9.5 × 27.0	B32232A1225+***	3600	2000
		3.3	11.5 × 27.0	B32232A1335+***	2000	2000
		4.7	12.0 × 32.0	B32232A1475+***	2000	2000
	6.8	14.0 × 32.0	B32232A1685+***	2000	1000	
250	160	0.10	6.0 × 14.0	B32232A3104+***	4000	2000
		0.15	7.0 × 14.0	B32232A3154+***	4000	2000
		0.22	6.0 × 19.0	B32232A3224+***	4000	2000
		0.33	7.0 × 19.0	B32232A3334+***	4000	2000
		0.47	8.0 × 19.0	B32232A3474+***	4000	2000
		0.68	8.0 × 27.0	B32232A3684+***	4000	2000
		1.0	10.0 × 27.0	B32232A3105+***	2000	2000
		1.5	10.0 × 32.0	B32232A3155+***	2000	2000
		2.2	11.0 × 32.0	B32232A3225+***	2000	2000
		3.3	14.0 × 32.0	B32232A3335+***	2000	1000
		4.7	16.5 × 32.0	B32232A3475+000	–	1000
	6.8	16.0 × 42.0	B32232A3685+000	–	800	
400	200	0.10	7.0 × 19.0	B32232A6104+***	4000	2000
		0.15	8.5 × 19.0	B32232A6154+***	4000	2000
		0.22	8.0 × 27.0	B32232A6224+***	4000	2000
		0.33	9.5 × 27.0	B32232A6334+***	3200	2000
		0.47	11.0 × 27.0	B32232A6474+***	2000	2000
		0.68	11.5 × 32.0	B32232A6684+***	2000	2000
		1.0	13.5 × 32.0	B32232A6105+***	2000	2000

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = ±10%

J = ±5%

*** = Packaging code:

189 = Reel

000 = Untaped


Ordering codes and packing units

V_R	V_{RMS} $f \leq 60$ Hz	C_R	Max. dimensions $d \times l$	Ordering code (composition see below)	Reel	Untaped
V DC	V AC	μF	mm		pcs./MOQ	pcs./MOQ
630	200	0.033	6.5 × 19.0	B32232A8333+***	4000	2000
		0.047	7.5 × 19.0	B32232A8473+***	4000	2000
		0.068	8.5 × 19.0	B32232A8683+***	4000	2000
		0.10	10.5 × 19.0	B32232A8104+***	2000	2000
		0.15	10.0 × 27.0	B32232A8154+***	2000	2000
		0.22	11.5 × 27.0	B32232A8224+***	2000	2000
		0.33	13.5 × 27.0	B32232A8334+***	2000	2000
		0.47	14.5 × 32.0	B32232A8474+000	–	2000
		0.68	15.0 × 32.0	B32232A8684+000	–	2000
		1.0	16.0 × 32.0	B32232A8105+000	–	2000

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

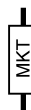
Composition of ordering code

+ = Capacitance tolerance code:
K = $\pm 10\%$
J = $\pm 5\%$

*** = Packaging code:
189 = Reel
000 = Untaped


B32232
General purpose (wound)
Technical data

Operating temperature range	Max. operating temperature $T_{op,max}$		+100 °C		
	Upper category temperature T_{max}		+100 °C		
	Lower category temperature T_{min}		-40 °C		
	Rated temperature T_R		+85 °C		
Dissipation factor $\tan \delta$ (in 10^{-3}) at 20 °C (upper limit values)	at	$C_R \leq 47$ nF	47 nF < $C_R \leq 1$ μ F	$C_R > 1$ μ F	
		1 kHz	10	10	10
		10 kHz	20	25	-
Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$ at 20 °C, rel. humidity $\leq 65\%$ (minimum as-delivered values)	V_R	$C_R \leq 0.33$ μ F		$C_R > 0.33$ μ F	
	100 V DC	3750 M Ω		1250 s	
	≥ 250 V DC	7500 M Ω		2500 s	
DC test voltage	$1.4 \cdot V_R, 2$ s				
Category voltage V_C (continuous operation with V_{DC} or V_{AC} at $f \leq 60$ Hz)	T_A (°C)	DC voltage derating		AC voltage derating	
	$T_A \leq 85$ $85 < T_A \leq 100$	$V_C = V_R$ $V_C = V_R \cdot (165 - T_A)/80$		$V_{C,RMS} = V_{RMS}$ $V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$	
Operating voltage V_{op} for short operating periods (V_{DC} or V_{AC} at $f \leq 60$ Hz)	T_A (°C)	DC voltage (max. hours)		AC voltage (max. hours)	
	$T_A \leq 100$	$V_{op} = 1.25 \cdot V_C$ (2000 h)		$V_{op} = 1.0 \cdot V_{C,RMS}$ (1000 h)	
Damp heat test Limit values after damp heat test	21 days/40 °C/93% relative humidity				
	Capacitance change $ \Delta C/C $		$\leq 5\%$		
	Dissipation factor change $\Delta \tan \delta$		$\leq 5 \cdot 10^{-3}$ (at 1 kHz) $\leq 7 \cdot 10^{-3}$ (at 10 kHz)		
	Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$		$\geq 20\%$ of minimum as-delivered values		



Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/ μ s.

"k₀" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/ μ s.

Note:

The values of dV/dt and k₀ provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

Length of capacitor		14 mm	19 mm	27 mm	32 mm	42 mm
V _R V DC	V _{RMS} V AC	dV/dt in V/ μ s				
100	63	6	3	2	1.5	–
250	160	10	5	3	2.5	2
400	200	–	7	4	3	–
630	200	–	10	7	5	–

k₀ values

Length of capacitor		14 mm	19 mm	27 mm	32 mm	42 mm
V _R V DC	V _{RMS} V AC	k ₀ in V ² / μ s				
100	63	1 200	600	400	300	–
250	160	5 000	2 500	1 500	1 250	1 000
400	200	–	5 600	3 200	2 400	–
630	200	–	12 500	8 800	6 300	–

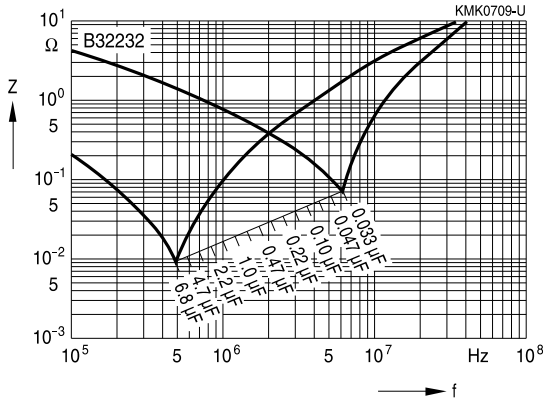


B32232

General purpose (wound)

Impedance Z versus frequency f

(typical values)



Permissible AC voltage V_{RMS} versus frequency f

Values can be obtained on request. In specific cases please provide a scaled voltage/ time graph and state operating conditions.



Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.

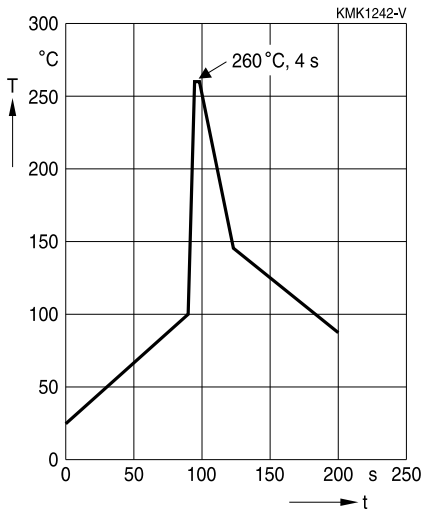
Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP (lead spacing > 7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤ 7.5 mm)		< 4 s
MKT uncoated (lead spacing ≤ 10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



B32232

General purpose (wound)



Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification



1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
 - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

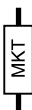
EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



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General purpose (wound)

2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

Type	Ethanol, isopropanol, n-propanol	n-propanol-water mixtures, water with surface tension-reducing tensides (neutral)	Solvent from table A (see next page)	Solvent from table B (see next page)
MKT (uncoated)	Suitable	Unsuitable	In part suitable	Unsuitable
MKT, MKP, MFP (coated/boxed)		Suitable	Suitable	

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70 °C) before they are subjected to subsequent electrical testing.

Table A

Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

Trifluoro-trichloro-ethane	Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol	Manufacturer
Freon TF	Freon TE 35; Freon TP 35; Freon TES	Du Pont
Frigen 113 TR	Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35	Hoechst
Arklone P	Arklone A; Arklone L; Arklone K	ICI
Kaltron 113 MDR	Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35	Kali-Chemie
Flugene 113	Flugene 113 E; Flugene 113 IPA	Rhone-Progil

Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons	Manufacturer
Freon TMC; Freon TA; Freon TC	Du Pont
Arklone E	ICI
Kaltron 113 MDD; Kaltron 113 MDK	Kali-Chemie
Flugene 113 CM	Rhone-Progil



3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100 °C.

Caution:

Consult us first if you wish to embed uncoated types!



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General purpose (wound)

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"



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General purpose (wound)

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_C	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β_C	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f_1	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I_C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



Symbol	English	German
I_{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impuls Kennwert
L_S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R_i	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_S	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtest)
t	Time	Zeit
T	Temperature	Temperatur
τ	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Ambient temperature	Umgebungstemperatur
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T_{op}	Operating temperature	Betriebstemperatur
T_R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer
V_{AC}	AC voltage	Wechselspannung



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Symbol	English	German
V_C	Category voltage	Kategorie spannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechsel spannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatz spannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_i	Input voltage	Eingangsspannung
V_o	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzen spannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
\hat{V}_R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechsel spannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechsel spannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
e	Lead spacing	Rastermaß

Important notes



The following applies to all products named in this publication:

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